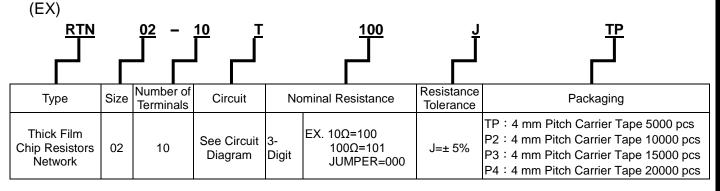


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#### 1 Scope:

- 1.1 This specification is applicable to lead free and halogen free of RoHS directive for RTN series thick film chip resistors network.
- 1.2 The product is for general electronic purpose.

### 2 Explanation Of Part Numbers:



### 3 General Specifications:

	- P- G		-						
Туре	Rated Power at	Max. Working	Max. Overload	T.C.R.	Resistance J(±5%)	Number of	Number of	JUMPER Rated	JUMPER Resistance
1,700	70℃	Voltage	Voltage	(bbm/℃)	E-12	Terminals		Power	Value
RTN02-10R	1/16 W	25V	50V	±200	47Ω~1ΜΩ	10	8	1A	50mΩ MAX.
RTN02-10T	1/16 W	25V	50V	±200	33Ω~1ΜΩ	10	8	1A	50mΩ MAX.
Operating Temperature Range					-55°C ~+	155℃			

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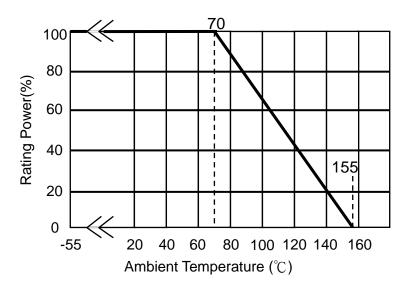


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#### 3.1 Power Derating Curve:

Operating Temperature Range : - 55 $\sim$ 155  $^{\circ}$ C

For resistors operated in ambient temperatures above  $70^{\circ}$ C, power rating shall be derated in accordance with figure below.



#### 3.2 Voltage Rating:

Rated Voltage: The resistor shall have a DC continuous working voltage or a rms. AC continuous working voltage at commercial-line frequency and wave form corresponding to the power rating, as determined from the following.

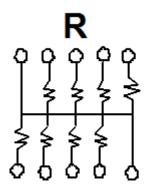
$$E = \sqrt{R \times P}$$

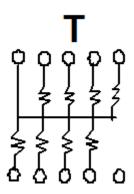
E= Rated voltage (V)

P= power rating (W)

 $R = Nominal resistance(\Omega)$ 

## 4 Circuit diagram:



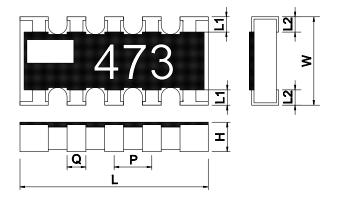


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# 5 Dimensions:



Unit: mm

DIM TYPE	L	W	Н	L1	L2	Р	Q
RTN02-10R	2 20 . 0 20	4 60 . 0 45	0.55.0.40	0.20.0.45	0.20.0.45	0.04.0.40	0.22.0.40
RTN02-10T	3.20±0.20	1.60±0.15	0.55±0.10	0.30±0.15	0.30±0.15	0.64±0.10	0.32±0.10

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# 6 Reliability Test:

## 6.1 Electrical Performance Test

Item	Conditions	Specifications		
пеш	Conditions	Resistors		
Temperature Coefficient of Resistance	TCR (ppm/°C) = $\frac{(R2-R1)}{R1 (T2-T1)}$ x10 <sup>6</sup> R1: Resistance at room temperature R2: Resistance at -55°C or +125°C T1: Room temperature T2: Temperature -55°C or +125°C Refer to JIS-C5201-1 4.8	Refer item 3. general Specifications		
Short Time Overload	Applied 2.5 times rated voltage for 5 seconds and release the load for about 30 minutes, then measure its resistance variance rate. (Rated voltage refer to item 3. general specifications)  Refer to JIS-C5201-1 4.13	ΔR=±2.0%		
Insulation Resistance	Put the resistor in the fixture, add 100 VDC in + ,- terminal for 60 sec then measured the insulation resistance between electrodes and insulating enclosure or between electrodes and base material.  Refer to JIS-C5201-1 4.6			
Dielectric Withstand Voltage	Put the resistor in the fixture, add 300 VAC in +,- terminal for 60 sec.  Refer to JIS-C5201-1 4.7	No short or burned on the appearance.		
Intermittent Overload	Put the tested resistor in chamber under temperature 25±2 °C and load 2.5 times rated DC voltage for 1 sec on , 25 sec off , 10000 +400 test cycles, then it be left at no-load for 1 hour , then measure its resistance variance rate.  Refer to JIS-C5201-1 4.13	∆R=±5.0%		

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## 6.2 Mechanical Performance Test

0	Specifications
Conditions	Resistors
The tested resistor be immersed into isopropyl alcohol of 20~25°C for 5 minutes, then the resistor is left in the room for 48 hrs, then measure its resistance variance rate.	△R=±0.5%
©Test method 1 (Solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 10 seconds. Then the resistor is left in the room for 1 hour. ©Test method 2 (Solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 30 seconds. Then the resistor is left as placed under microscope to observe its solder area. Refer to JIS-C5201-1 4.18	Test item 1:  (1).Variance rate on resistance  ΔR%=±1.0%  Test item 2:  (1).Solder coverage over 95%.  (2).The underlying material(such as ceramic) shall not be visible at the crest corner area of the electrode.
Preconditioning: Put the tested resistor in the apparatus of PCT, at a temperature of 105°C, humidity of 100% RH, and pressure of 1.22×105 Pa for a duration of 4 hours. Then after left the tested resistor in room temperature for 2 hours or more. Test method: The tested resistor be immersed into solder pot in temperature 230±5°C for 2 sec, then the resistor is left as placed under microscope to observed its solder area.  Refer to JIS-C5201-1 4.17	Solder coverage over 95%
	ΔR%=±1.0%
	20~25℃ for 5 minutes, then the resistor is left in the room for 48 hrs, then measure its resistance variance rate.  Refer to JIS-C5201-1 4.29  ③Test method 1 (Solder pot test):  The tested resistor be immersed into molten solder of 260+5/-0℃ for 10 seconds. Then the resistor is left in the room for 1 hour.  ⑤Test method 2 (Solder pot test):  The tested resistor be immersed into molten solder of 260+5/-0℃ for 30 seconds. Then the resistor is left as placed under microscope to observe its solder area. Refer to JIS-C5201-1 4.18  Preconditioning:  Put the tested resistor in the apparatus of PCT, at a temperature of 105℃, humidity of 100% RH, and pressure of 1.22×105 Pa for a duration of 4 hours. Then after left the tested resistor in room temperature for 2 hours or more. Test method:  The tested resistor be immersed into solder pot in temperature 230±5℃ for 2 sec, then the resistor is left as placed under microscope to observed its solder area.  Refer to JIS-C5201-1 4.17  ⑤Bending Strength: Solder tested resistors on to PC board. add force in the middle down , and under load measure its resistance variance rate.  D = 5 mm  Resistor  Testing circuit board  Supporting jig  Pressurize  OHM Meter

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### 6.3 Environmental Test

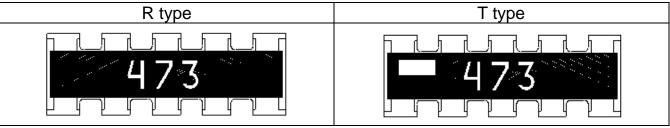
Item	Conditions	Specifications Resistors	
	Put tested resistors in chamber under temperatur		
Resistance to Dry Heat	or 1,000±4 hours. Then leaving in room tempera ninutes, and measure its resistance variance rate	ture for 60	
	Refer to JIS-C5201-1 4.25		
	Put the tested resistor in the thermal shock cham emperature cycle which shown in the following to epeated 300 times consecutively. Then leaving the esistor in the room temperature for 1 hour, and resistance variance rate.	able shall be he tested	
Thermal Shock	Testing Condition		
	Lowest Temperature -55±5°		
	Highest Temperature 125±5°		
	Temperature-retaining time 15 minutes	each	
	Refer to MIL-STD 202 Method 107		
Loading Life in Moisture	Put the tested resistor in the chamber under temperature 40±2°C, relative humidity 90~95% and load the rated voltage for 90 minutes on, 30 minutes off, total 1000 hours. Then leaving the tested resistor in room temperature for 60 minutes, and measure its resistance variance rate.  Refer to JIS-C5201-1 4.24		
Load Life	Put the tested resistor in chamber under tempera and load the rated voltage for 90 minutes on, 30 rotal 1000 hours. Then leaving the tested resistor emperature for 60 minutes, and measure its resistance rate.  Refer to JIS-C5201-1 4.25	ninutes off, in room	

## 7 Plating Thickness:

7.1 Ni: $\geq$ 2 $\mu$ m

7.2 Sn (Lead Free):  $\ge 3\mu\mathrm{m}$  7.3 Sn (Tin): Matte Sn

# 8 Chip Resistors Network Appearance:

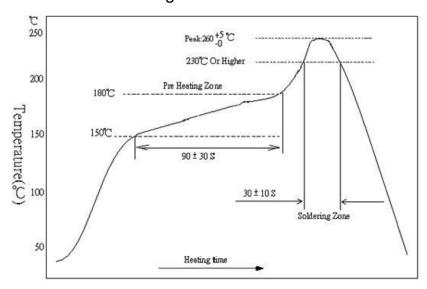


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- 9 Technical application notes: (This is for recommendation, please customer perform adjustment according to actual application)
  - 9.1 Recommend Soldering Method:
    - 9.1.1 Lead Free IR-Reflow Soldering Profile



Remark: The peak temperature of soldering heat is 260 +5/-0 °C for 10 seconds.

9.1.2 Soldering Iron: temperature 350°C  $\pm$ 10°C , dwell time shall be less than 3 sec.

### 9.2 Recommend Land Pattern Design (For Reflow Soldering):

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.

Unit: mm

P	DIM TYPE	Α	В	С	D	Р
A A B	RTN02	2.6	1.0	0.34	0.30	0.64

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#### 9.3 Environment Precautions:

This specification product is for general electronic use, ABCO will not be responsible for any damage, cost or loss caused by using this specification product in any special environment. If other applications need to confirm with ABCO.

If consumer intends to use our Company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 \ H2S \ NH3 \ SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.

#### 9.4 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving.

#### 9.5 Operation and Processing Precautions:

- (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
- (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature.
- (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
- (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of it's fail-safe design to ensure the system safety.

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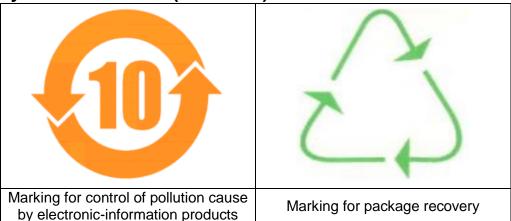


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#### 10 Storage and transportation requirement:

- 10.1 The temperature condition must be controlled at 25±5°C, the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years ∘
- 10.2 Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as CI2 \ H2S \ NH3 \ SO2 and NO2.
- 10.3 When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

11 The carton packaged for electronic-information products is made by the symbol as follows: (For china)





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